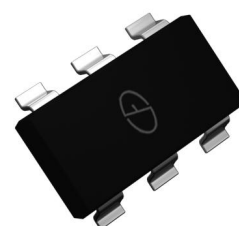


## Switching Diode

### Features

- Fast Switching Device (TRR <4nS)
- Power Dissipation of 200mW
- Low reverse leakage
- High Stability and High Reliability
- RoHS Compliant



Marking: .KA2

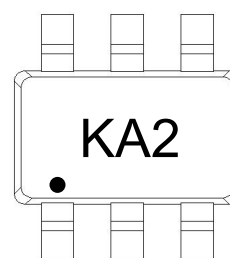
SOT-363

### Applications

- High speed switching

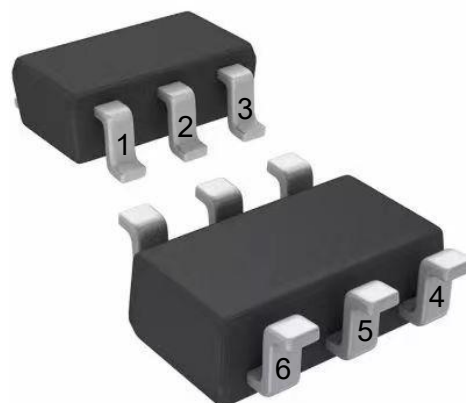
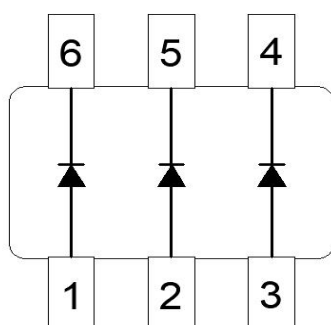
### Mechanical Data

- Package: SOT-363
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Tape Reel :3000pcs



### Pin definition

### Equivalent circuit

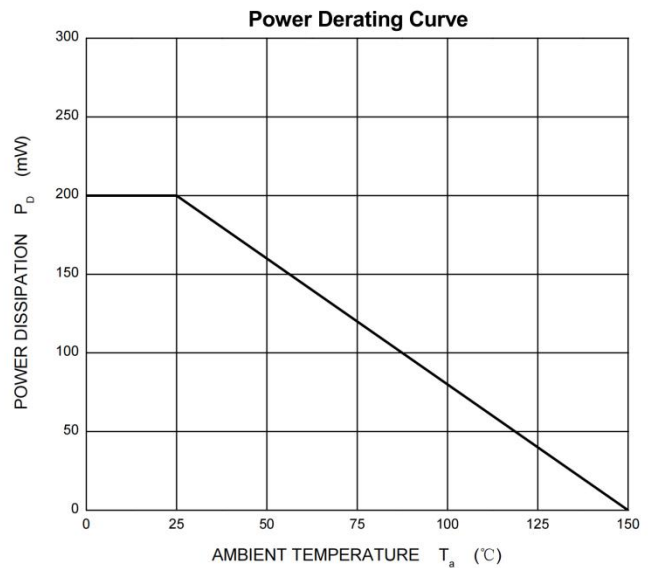
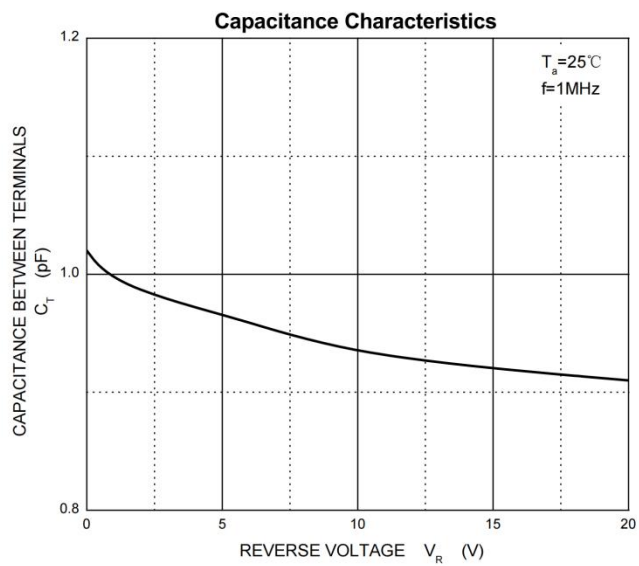
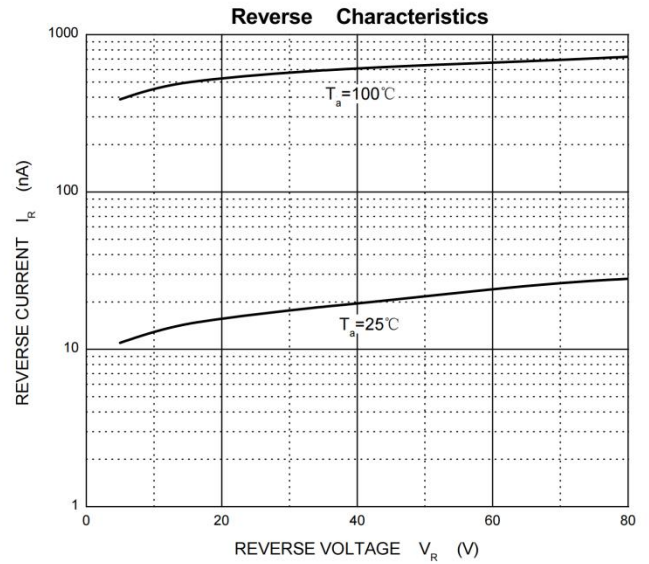
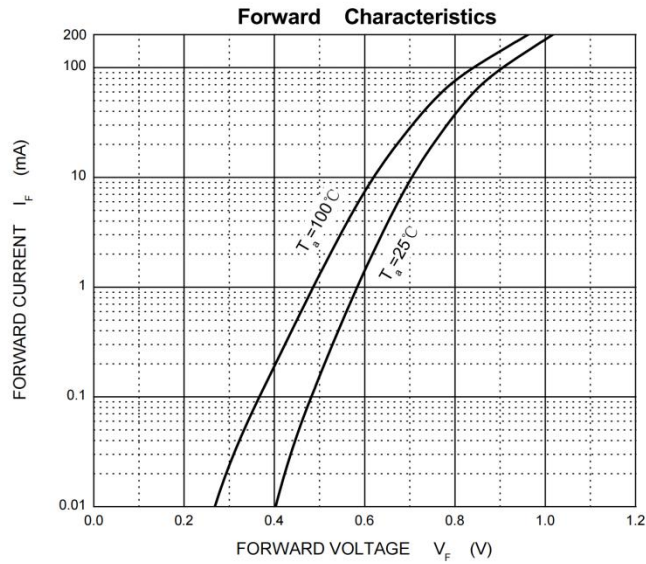


| Maximum Ratings & Electrical Characteristics (T <sub>A</sub> =25°C unless otherwise noted) |                  |            |      |
|--------------------------------------------------------------------------------------------|------------------|------------|------|
| Parameter                                                                                  | Symbol           | Value      | Unit |
| Peak reverse voltage                                                                       | V <sub>RM</sub>  | 100        | V    |
| Continuous Reverse voltage                                                                 | V <sub>R</sub>   | 75         | V    |
| Average rectified output current                                                           | I <sub>O</sub>   | 150        | mA   |
| Non-repetitive Peak Forward Current                                                        | I <sub>FM</sub>  | 300        | mA   |
| Non-repetitive Peak Forward Surge Current@t=8.3ms                                          | I <sub>FSM</sub> | 2          | A    |
| Power Dissipation                                                                          | P <sub>D</sub>   | 200        | mW   |
| Thermal Resistance Junction to Ambient                                                     | R <sub>θJA</sub> | 625        | °C/W |
| Junction temperature Range                                                                 | T <sub>J</sub>   | -55 ~ +150 | °C   |
| Storage Temperature                                                                        | T <sub>STG</sub> | -55 ~ +150 | °C   |

| Electrical Specifications (T <sub>A</sub> =25°C unless otherwise noted) |                 |                                                                                                               |        |       |      |
|-------------------------------------------------------------------------|-----------------|---------------------------------------------------------------------------------------------------------------|--------|-------|------|
| Parameter                                                               | Symbol          | Test Conditions                                                                                               | Limits |       | Unit |
|                                                                         |                 |                                                                                                               | Min    | Max   |      |
| Reverse Breakdown Voltage                                               | V <sub>BR</sub> | I <sub>R</sub> = 100μA                                                                                        | 100    |       | V    |
|                                                                         |                 | I <sub>R</sub> = 5μA                                                                                          | 75     |       | V    |
| Reverse Leakage Current                                                 | I <sub>R</sub>  | V <sub>R</sub> = 20V                                                                                          |        | 25    | nA   |
|                                                                         |                 | V <sub>R</sub> = 75V                                                                                          |        | 1     | uA   |
| Forward Voltage                                                         | V <sub>F</sub>  | I <sub>F</sub> = 1.0mA                                                                                        |        | 0.715 | V    |
|                                                                         |                 | I <sub>F</sub> = 10mA                                                                                         |        | 0.855 | V    |
|                                                                         |                 | I <sub>F</sub> = 50mA                                                                                         |        | 1     | V    |
|                                                                         |                 | I <sub>F</sub> = 150mA                                                                                        |        | 1.25  | V    |
| Junction Capacitance                                                    | C <sub>J</sub>  | V <sub>R</sub> = 0, f = 1.0MHz                                                                                |        | 2     | pF   |
| Reverse Recovery Time                                                   | T <sub>RR</sub> | I <sub>F</sub> = I <sub>R</sub> = 10mA,<br>I <sub>rr</sub> = 0.1 × I <sub>R</sub> ,<br>R <sub>L</sub> = 100 Ω |        | 4     | ns   |

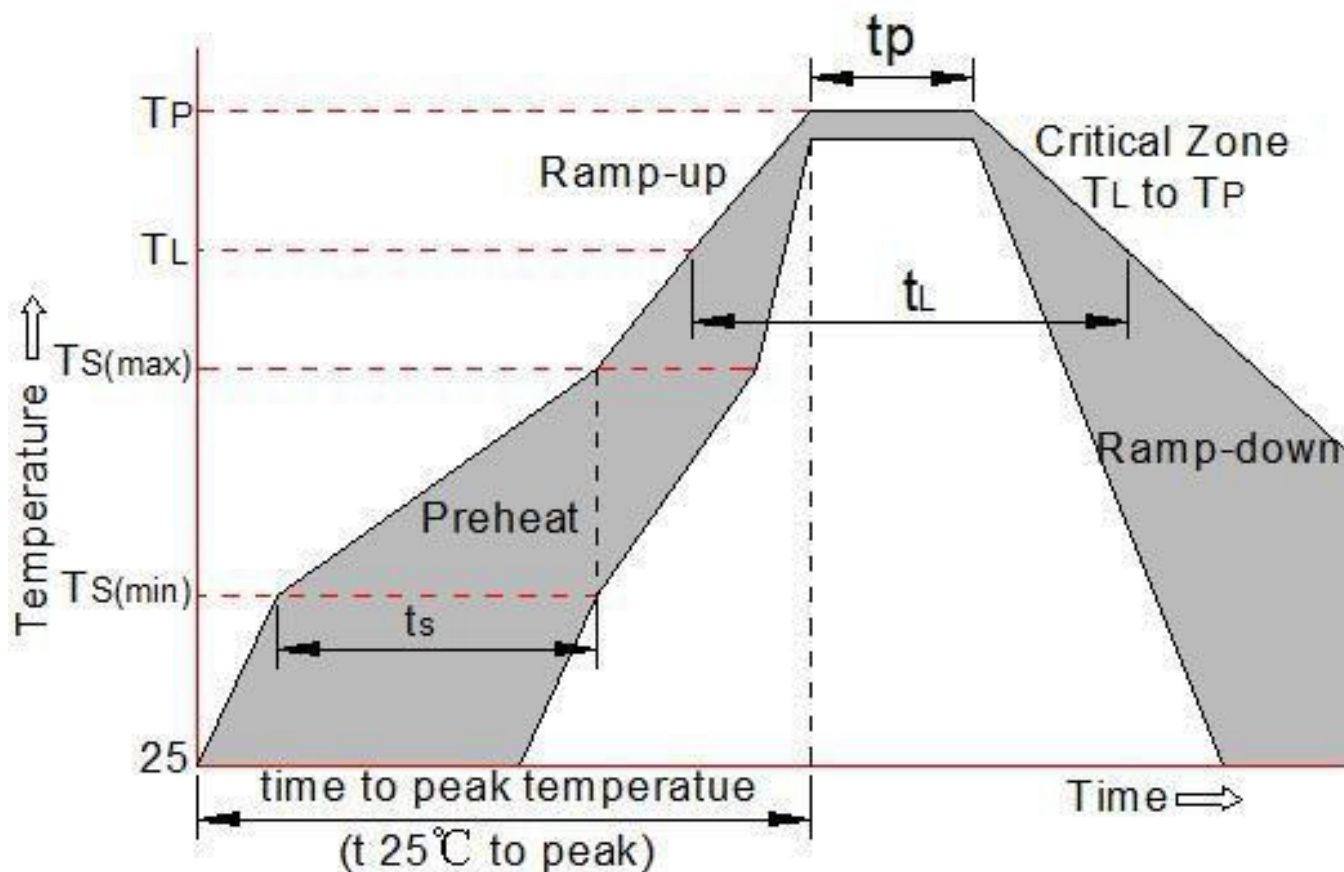
## Ratings and Characteristics Curves

( $T_A = 25^\circ\text{C}$  unless otherwise noted)



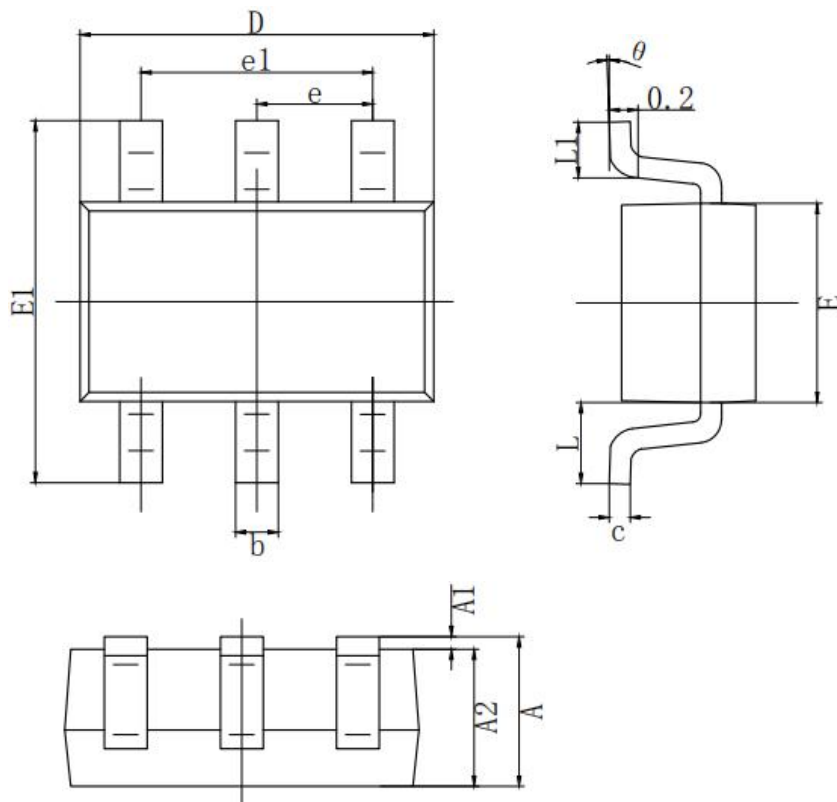
## Soldering Parameters

| Reflow Condition                                        |                                   | Pb -Free assembly<br>(see as bellow) |
|---------------------------------------------------------|-----------------------------------|--------------------------------------|
| Pre Heat                                                | -Temperature Min ( $T_{s(min)}$ ) | +150 °C                              |
|                                                         | -Temperature Max( $T_{s(max)}$ )  | +200 °C                              |
|                                                         | -Time (Min to Max) ( $t_s$ )      | 60 -180 secs.                        |
| Average ramp up rate (Liquid us Temp ( $T_L$ ) to peak) |                                   | 3 °C /sec. Max                       |
| $T_{s(max)}$ to $T_L$ - Ramp -up Rate                   |                                   | 3 °C /sec. Max                       |
| Reflow                                                  | -Temperature( $T_L$ ) (Liquid us) | +217 °C                              |
|                                                         | -Temperature( $t_L$ )             | 60 -150 secs.                        |
| Peak Temp ( $T_p$ )                                     |                                   | +260(+0/ -5) °C                      |
| Time within 5 °C of actual Peak Temp ( $t_p$ )          |                                   | 30 secs. Max                         |
| Ramp -down Rate                                         |                                   | 6 °C /sec. Max                       |
| Time 25 °C to Peak Temp ( $T_p$ )                       |                                   | 8 min. Max                           |
| Do not exceed                                           |                                   | +260 °C                              |



## Package Outline Dimensions

millimeters



| SYMBOL | MILLIMETER |       |
|--------|------------|-------|
|        | MIN        | MAX   |
| A      | 0.900      | 1.100 |
| A1     | 0.000      | 0.100 |
| A2     | 0.900      | 1.000 |
| b      | 0.150      | 0.350 |
| c      | 0.080      | 0.150 |
| D      | 2.000      | 2.200 |
| E      | 1.150      | 1.350 |
| E1     | 2.150      | 2.450 |
| e      | 0.650 TYP. |       |
| e1     | 1.200      | 1.400 |
| L      | 0.525 REF. |       |
| L1     | 0.260      | 0.460 |
| θ      | 0°         | 8°    |

## Revision History

| Document Version | Date of release | Description of changes |
|------------------|-----------------|------------------------|
| Rev.A            | 2017.06.13      | First issue            |
|                  |                 |                        |
|                  |                 |                        |

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